

PATENT**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re application of: Chien-Ping HUANG

Serial No.: 09/665,818

Group No.: 2814

Filed: September 20, 2000

Examiner: Tran, T.

For: SEMICONDUCTOR PACKAGE FOR ENHANCING HEAT DISSIPATION

Attorney Docket No.: U 013803-1

Assistant Commissioner for Patents
Washington, D.C. 20231

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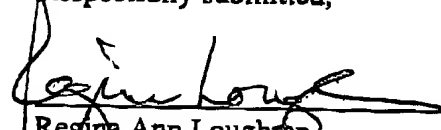
MAR 12 2002

TECHNOLOGY CENTER 2800

Letter to the Examiner

A substitute specification was filed for the above-identified application on March 11, 2002. Applicant's attorney hereby declares that no new matter is added therein.

Respectfully submitted,


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